



Another EMC resource
from EMC Standards

5 - EMC techniques for heatsinks - Updated Jan 2021



emc14f v2.8

Helping you solve your EMC problems

Keith Armstrong

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Module 5: EMC techniques for heatsinks



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Change Record: v2.6 – v2.8, Jan 2021

- **Safety note applied to all slides, with some reformatting**
- Slide 5.4.2 – text improved a little
- Slide 5.10.2 – text improved
- Slide 5.10.8 – new supplier added
- **New slide 5.11.9 added**
'A different proprietary method of combining BLS with cooling'

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Good Electromagnetic (EM) Engineering...

- is cost-effective SI, PI and EMC engineering:
well-proven to save time & money in all lifecycle stages,
helping to increase profits & reduce financial risks...
- for PCBs, modules, sub-assemblies, devices, products, equipment, vehicles, sub-systems, systems, installations, etc., etc.; of any size, in all applications
see Module 1 especially 1.15 (also in Webinar 1c) and 1.16 (also in Webinar 1d)

■ **This Module contains many EM Engineering guidelines that should *also* be used as an initial design checklist:**
any that can't or won't be followed identify a project risk!
see Module 1, section 1.16 (also in Webinar 1d)

- to adapt any λ -based design guidelines to different EMC standards, see *Module 1, section 1.18* *also in Webinar 1d*

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- 5.1 Importance of controlling stray heatsink currents
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- 5.3 Returning stray heatsink currents to their sources
- 5.4 Using the PCB's Reference Plane as a heatsink
- 5.5 Practical RF-bonding issues
- 5.6 Heat sink RF resonances
- 5.7 Resonance effects of heat sink shapes, fins, pins, and the locations of the semiconductors
- 5.8 Heat pipes
- 5.9 Some techniques that could be useful
- 5.10 Low-inductance bonding to control resonances to GHz
- 5.11 Combining shielding with heatsinking
- 5.12 Some useful references

For safety requirements, see our training courses on design for safety compliance

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5. EMC techniques for heatsinks

5.1

Importance of controlling stray heatsink currents

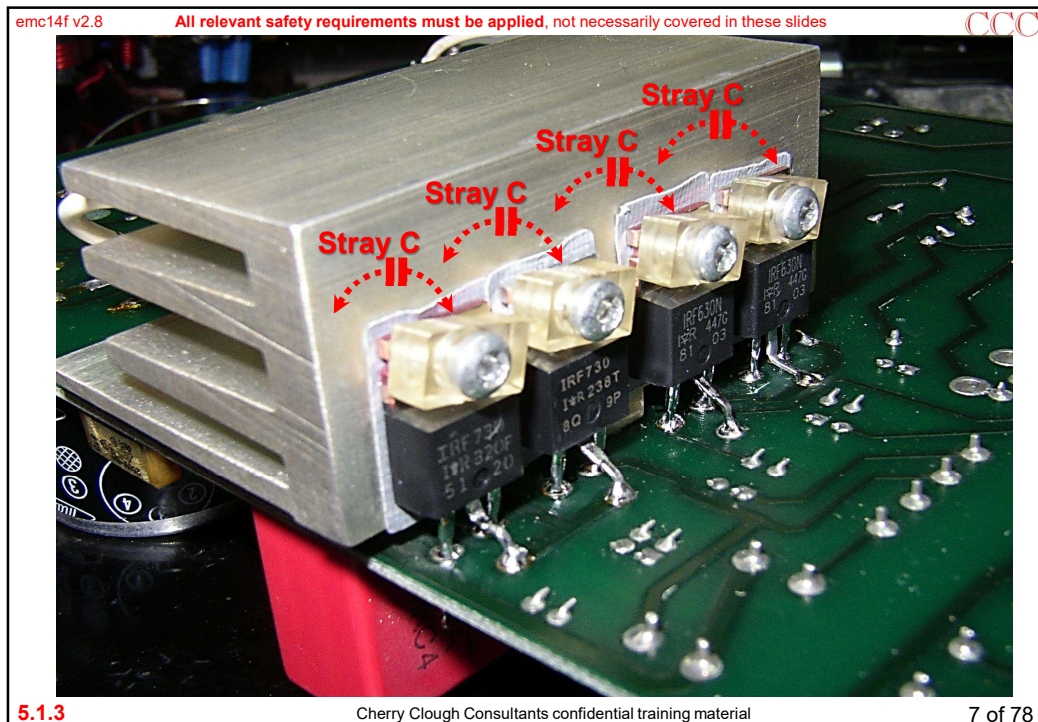
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Controlling stray heatsink currents

- An IC or transistor fitted with a heatsink has a significant stray capacitance to that heatsink...
 - because its thermal interface washer is thin, and has a high value of dielectric constant (ϵ_r)...
 - and sometimes devices are bonded directly to a heatsink
 - when the voltages of the IC or power transistor fluctuate, this stray capacitance injects stray currents into *conductive* heatsinks...
 - returning these stray currents to their sources,
 - the power supply for the IC or transistor,
 - is *very important indeed* for controlling EMC emissions

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5. EMC techniques for heatsinks

5.2

Ceramic and plastic heatsinks have no stray currents

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Ceramic or plastic heatsinks

-have no stray currents, because they are not conductive (e.g. “CeramCool”, “CoolPoly”)...
 - and they do not need thermal insulating washers so can sometimes have better heat dissipation than metal...
 - as well as having no EMC emissions...
 - and some can have metallised/etched surfaces, like a single-layer PCB, allowing direct bonding of devices...
 - especially good for power LED arrays
- But device heatsink ‘tabs’ will still emit...
 - so some of the following techniques may still be required


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Examples of thermally-conductive plastic heatsinks

For ICs
(glued in place with
thermally-conductive epoxy)

For LED lamp
 housings



Laird TECHNOLOGIES
Innovative Technology for a Connected World
Conductive Plastics

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